



November 2013

FCH22N60N N-Channel SupreMOS[®] MOSFET 600 V, 22 A, 165 mΩ

Features

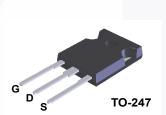
- 650 V @ T_J = 150°C
- $R_{DS(on)}$ = 140 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 11 A
- Ultra Low Gate Charge (Typ. Q_q = 45 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 196.4 pF)
- 100% Avalanche Tested
- RoHS Compliant

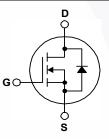
Application

- PDP TV
- Solar Inverter
- AC-DC Power Supply

Description

The SupreMOS[®] MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			FCH22N60N	Unit	
V _{DSS}	Drain to Source Voltage			600	V	
V _{GSS}	Gate to Source Voltage			±30	V	
	Drain Current	- Continuous (T _C = 25 ^o C)		22	— A	
ID		- Continuous (T _C = 100 ^o C)		13.8		
I _{DM}	Drain Current	- Pulsed (N	lote 1)	66	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			672	mJ	
I _{AR}	Avalanche Current (Note 1)			7.3	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)			2.75	mJ	
-1 / -14	MOSFET dv/dt			100	V/ns	
dv/dt	Peak Diode Recovery dv	/dt (N	lote 3)	20	v/ns	
P _D	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		205	W	
		- Derate Above 25°C		1.64	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		ds	300	°C	

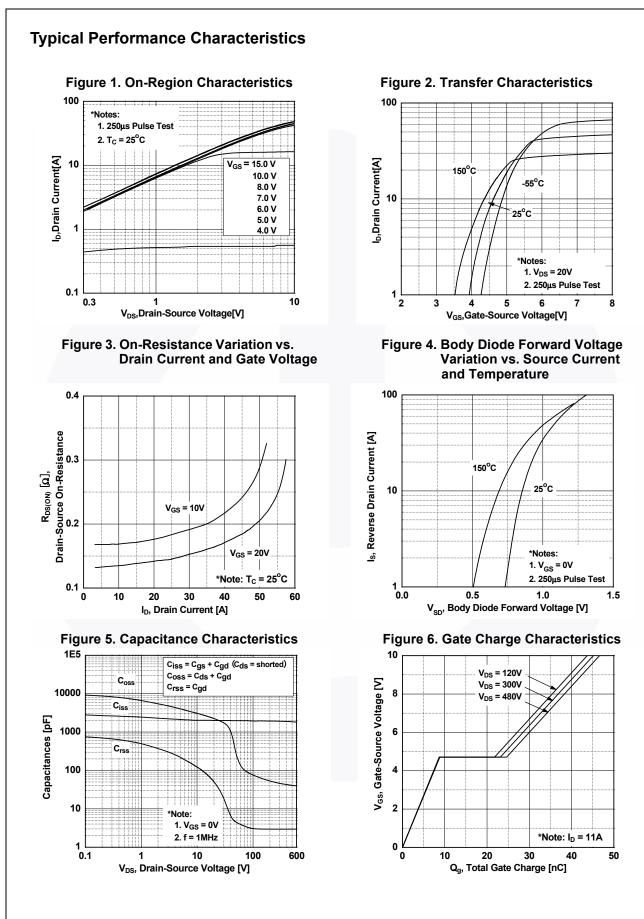
Thermal Characteristics

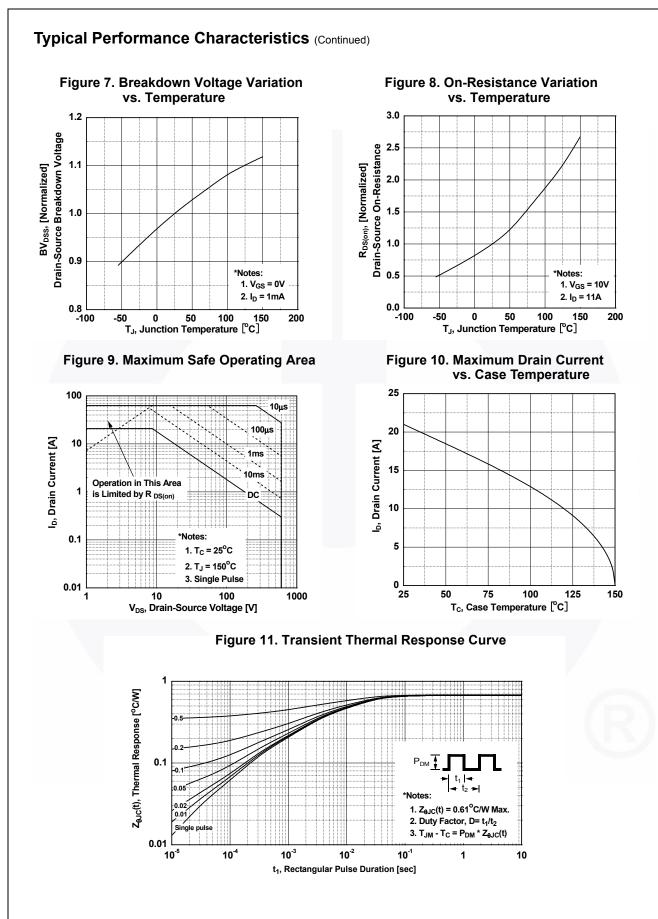
Symbol	Parameter	FCH22N60N	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.61	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	0,00

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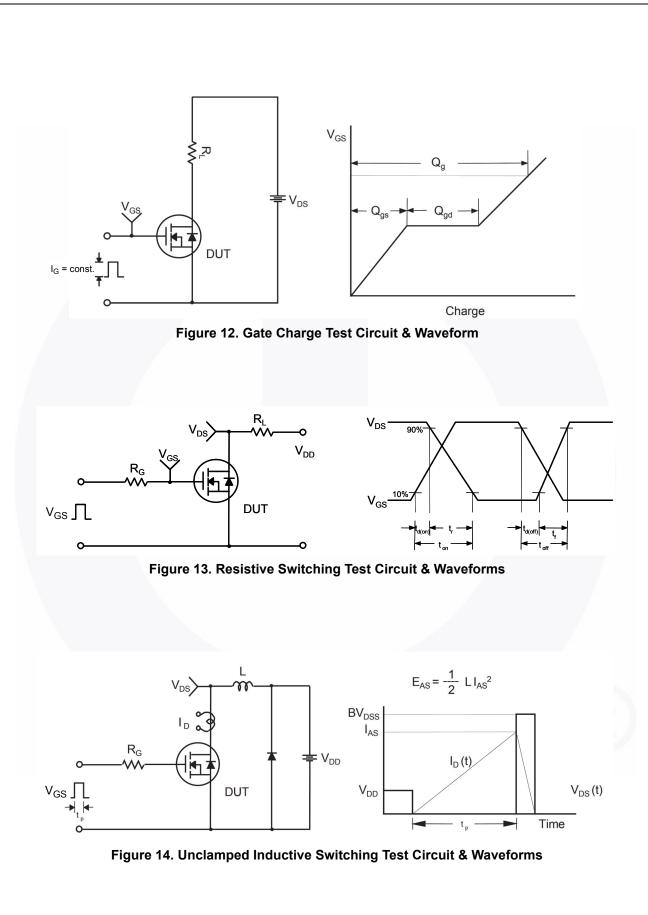
Part Number Top Mark FCH22N60N FCH22N60N		Package	Packing Method	Reel Siz	е	Tape Width	Qu	antity	
		TO-247	Tube	N/A		N/A	30	30 units	
Inctrica	l Chara	cteristics T _C = 25°C	uploss other	wise poted					
Symbol		Parameter		Test Condition	s	Min.	Тур.	Max.	Unit
Off Charac	toristics				5		190.	max.	onic
				4 A \/	0500	600			1
BV _{DSS}	Drain to S	Source Breakdown Voltage		$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_J = 25^{\circ}\text{C}$ $I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_J = 150^{\circ}\text{C}$			-	-	V
ΔBV _{DSS} / ΔT _J	Breakdov Coefficier	vn Voltage Temperature nt	_	$I_D = 1 \text{ mA}$, Referenced to 25°C			0.68	-	V/ºC
	Zero Gat	e Voltage Drain Current		s = 480 V, V _{GS} = 0 V		-	-	10	μA
DSS	Zero Gat	e voltage brain current		_s = 480 V, T _J = 125 ^o C			-	100	μΛ
GSS	Gate to B	ody Leakage Current	V _{GS}	$_{\rm S} = \pm 50 \text{ V}, \text{ V}_{\rm DS} = 0 \text{ V}$		-	-	±100	nA
On Charac	teristics								
V _{GS(th)}	Gate Thr	eshold Voltage	V _G s	_S = V _{DS} , I _D = 250 μA		2.0	3	4.0	V
R _{DS(on)}	Static Dra	ain to Source On Resistanc	e V _G	_S = 10 V, I _D = 11 A		-	0.140	0.165	Ω
ĴFS	Forward	Transconductance		_s = 20 V, I _D = 11 A		-	22	-	S
Dynamic C	haracter	ristics							
C _{iss}	Input Cap					-	1950	-	pF
S _{oss}		apacitance		V _{DS} = 100 V, V _{GS} = 0 V f = 1 MHz		-	75.9	-	pF
Since Section 2005		Transfer Capacitance	f = '				3	_	pF
Coss	Output Capacitance		Var	V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz			43.2	-	pF
Coss(eff.)		1		$r_{s} = 0 \text{ V to } 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	196.4	_	pF
	Effective Output Capacitance Total Gate Charge at 10V				- 0 V	_	45	_	nC
ס _{g(tot)}		ource Gate Charge		s = 380 V, I _D = 11 A,	-		8.7	_	nC
2 _{gs}		rain "Miller" Charge	V GS	_S = 10 V	(Note 4)		14.5	_	nC
ຊ _{gd} ESR		nt Series Resistance (G-S)	f - 1	1 MHz	(-	14.5	-	Ω
			1-			-	•	-	52
Switching									
t _{d(on)}		Delay Time		V_{DD} = 380 V, I _D = 11 A R _G = 4.7 Ω		-	16.9	-	ns
r		Rise Time				-	16.7	-	ns
d(off)		Delay Time	чG	- 4.7 32		-	49	-	ns
f	Turn-Off I	Fall Time			(Note 4)	-	4	-	ns
)rain-Sou	ce Diode	e Characteristics							
S	Maximum	Continuous Drain to Source	ce Diode For	ward Current		-	-	22	Α
SM	Maximum	Pulsed Drain to Source Di				-	-	66	Α
/ _{SD}	Drain to S	Source Diode Forward Volta	age V _{GS}	_S = 0 V, I _{SD} = 11 A		-	-	1.2	V
rr	Reverse F	Recovery Time	V _{GS}	_s = 0 V, I _{SD} = 11 A		-	350	-	ns
2 _m	Reverse F	Recovery Charge	dl _F /	dt = 100 A/µs		-	6	-	μC
I _{AS} = 7.3 A, R _G = I _{SD} ≤ 22 A, di/dt	= 25 Ω, starting ≤ 200 A/μs, V _D	nited by maximum junction tempera T _J = 25°C. $_{D} \le 380$ V, starting T _J = 25°C. ating temperature typical characteri							

FCH22N60N — N-Channel SupreMOS[®] MOSFET

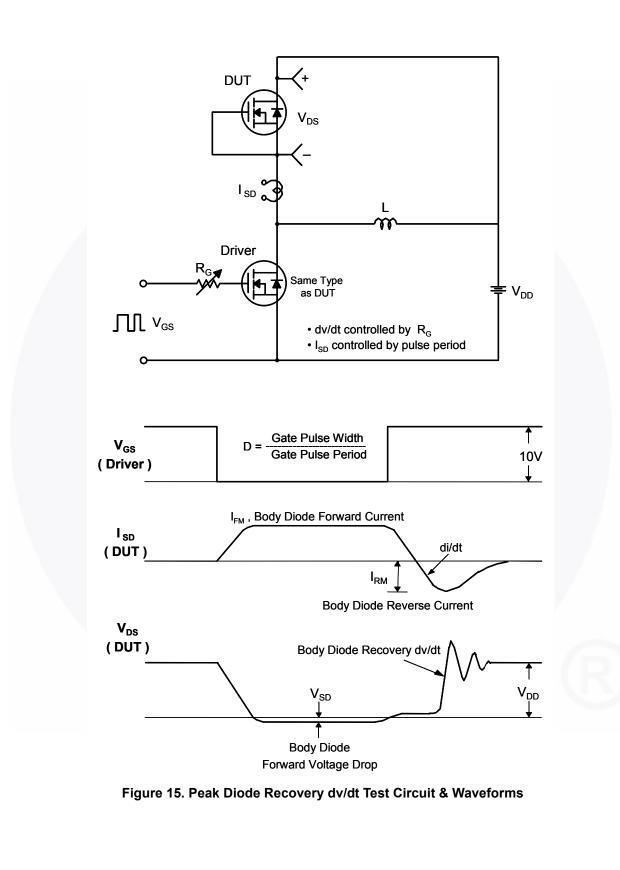


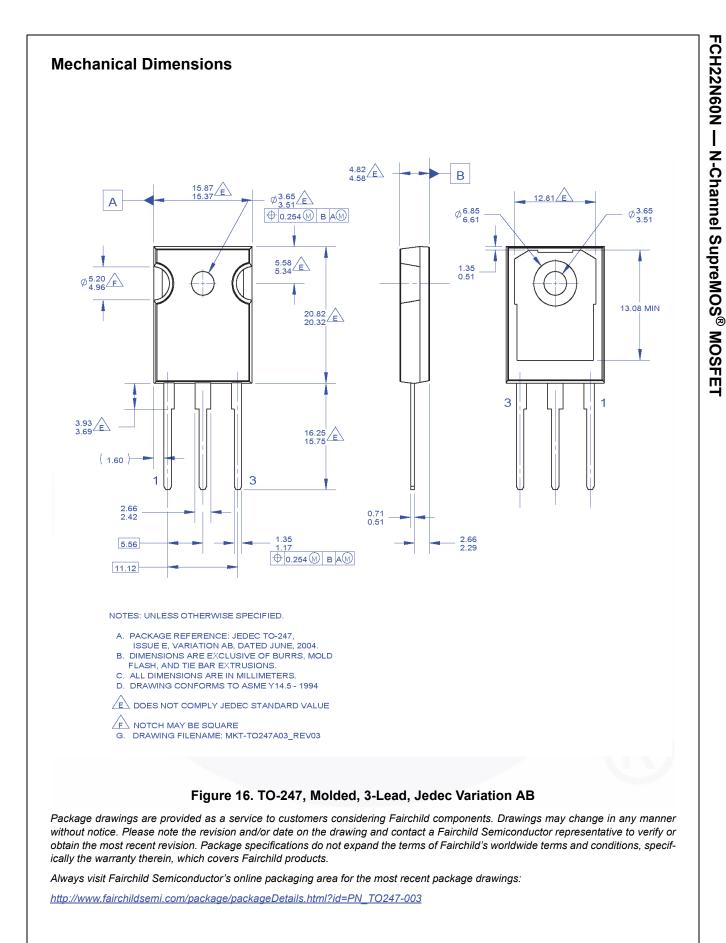


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FCH22N60N Rev. C1

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